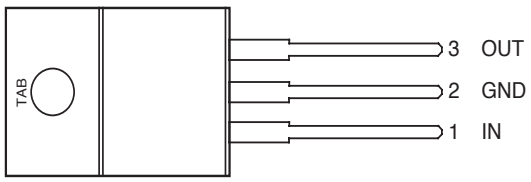
Ordering Information

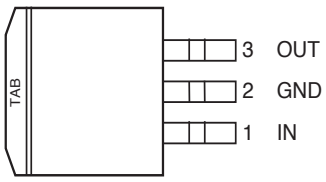
Part Number		Voltage	Junction Temp. Range	Package
Standard	RoHS Compliant*			
MIC39500-2.5BT	MIC39500-2.5WT*	2.5V	-40°C to +125°C	3-Lead TO-220
MIC39500-2.5BU	MIC39500-2.5WU*	2.5V	-40°C to +125°C	3-Lead TO-263
MIC39501-2.5BT	MIC39501-2.5WT*	2.5V	-40°C to +125°C	5-Lead TO-220
MIC39501-2.5BU	MIC39501-2.5WU*	2.5V	-40°C to +125°C	5-Lead TO-263
MIC39500-1.8BT	MIC39500-1.8WT*	1.8V	-40°C to +125°C	3-Lead TO-220
MIC39500-1.8BU	MIC39500-1.8WU*	1.8V	-40°C to +125°C	3-Lead TO-263
MIC39501-1.8BT	MIC39501-1.8WT*	1.8V	-40°C to +125°C	5-Lead TO-220
MIC39501-1.8BU	MIC39501-1.8WU*	1.8V	-40°C to +125°C	5-Lead TO-263

* RoHS compliant with high-melting solder exemption.

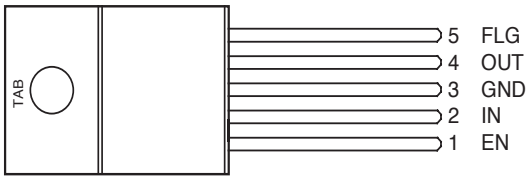
Pin Configuration



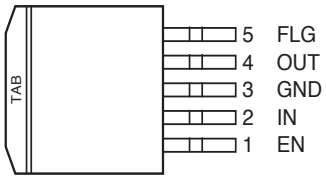
MIC39500-x.xBT
TO-220-3 (T)



MIC39500-x.xBU
TO-263-3 (U)



MIC39501-x.xBT
TO-220-5 (T)



MIC39501-x.xBU
TO-263-5 (U)

Pin Description

Pin Number MIC39500	Pin Number MIC39501	Pin Name	Pin Function
	1	EN	Enable (Input): TTL/CMOS compatible input. Logic high = enable; logic low or open = shutdown
1	2	IN	Unregulated Input: +16V maximum supply.
2, TAB	3, TAB	GND	Ground: Ground pin and TAB are internally connected.
3	4	OUT	Regulator Output
	5	FLG	Error Flag (Ouput): Open collector output. Active low indicates an output fault condition.

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Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{IN}).....–20V to +20V
Enable Voltage (V_{EN}) .....+20V
Storage Temperature (T_S) ..... –65°C to +150°C
Lead Temperature (soldering, 5 sec.)..... 260°C
ESD, **Note 3**

Operating Ratings (Note 2)

Supply Voltage (V_{IN})..... +2.25V to +16V
Enable Voltage (V_{EN}) .....+16V
Maximum Power Dissipation ($P_{D(max)}$)..... **Note 4**
Junction Temperature (T_J)..... –40°C to +125°C
Package Thermal Resistance
TO-263 (θ_{JC}) .....2°C/W
TO-220 (θ_{JC}) .....2°C/W

Electrical Characteristics

T_J = 25°C, **bold** values indicate –40°C ≤ T_J ≤ +125°C; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OUT}	Output Voltage	10mA 10mA ≤ I_{OUT} ≤ 5A, V_{OUT} + 1V ≤ V_{IN} ≤ 16V	–1 **–2**		1 **2**	% %
	Line Regulation	I_{OUT} = 10mA, V_{OUT} + 1V ≤ V_{IN} ≤ 16V		0.06	0.5	%
	Load Regulation	V_{IN} = V_{OUT} + 1V, 10mA ≤ I_{OUT} ≤ 5A		0.2	1	%
$\Delta V_{OUT}/\Delta T$ ppm/°C	Output Voltage Temp. Coefficient, **Note 5**			**20**	**100**	
V_{DO}	Dropout Voltage, **Note 6**	I_{OUT} = 250mA, ΔV_{OUT} = –2%		125	**250**	mV
		I_{OUT} = 2.5A, ΔV_{OUT} = –2%		320		mV
		I_{OUT} = 5A, ΔV_{OUT} = –2%		400	**575**	mV
I_{GND}	Ground Current, **Note 7**	**I_{OUT}** = 2.5A, V_{IN} = V_{OUT} + 1V		15	**50**	mA
		I_{OUT} = 5A, V_{IN} = V_{OUT} + 1V		70		mA
$I_{GND(do)}$	Dropout Ground Pin Current	V_{IN} ≤ $V_{OUT(nominal)}$ – 0.5V, I_{OUT} = 10mA		2.1		mA
$I_{OUT(lim)}$	Current Limit	V_{OUT} = 0V, V_{IN} = V_{OUT} + 1V		7.5		A
e_n µV(rms)	Output Noise Voltage	C_{OUT} = 47µF, I_{OUT} = 100mA, 10Hz to 100kHz		260		
Enable Input (MIC39501)						
V_{EN}	Enable Input Voltage	logic low (off)			**0.8**	V
		logic high (on)	**2.25**			V
I_{IN}	Enable Input Current	V_{EN} = V_{IN}		30	35 **75**	µA µA
		V_{EN} = 0.8V			2 **4**	µA µA
$I_{OUT(shdn)}$	Shutdown Output Current	**Note 8**		10	**20**	µA
Flag Output (MIC39501)						
$I_{FLG(leak)}$	Output Leakage Current	V_{OH} = 16V		0.01	1 **2**	µA µA
$V_{FLG(do)}$	Output Low Voltage	V_{IN} = 2.250V, I_{OL}, = 250µA, **Note 9**		180	300 **400**	mV mV
V_{FLG}	Low Threshold	1% of V_{OUT}	93			%
	High Threshold	1% of V_{OUT}			99.2	%
	Hysteresis			1		%

Note 1. Exceeding the absolute maximum ratings may damage the device.

Note 2. The device is not guaranteed to function outside its operating rating.

Note 3. Devices are ESD sensitive. Handling precautions recommended.

Note 4. $P_{D(max)} = (T_{J(max)} - T_A) \div \theta_{JA}$, where θ_{JA} depends upon the printed circuit layout. See "Applications Information."

Note 5. Output voltage temperature coefficient is $\Delta V_{OUT(worst\ case)} \div (T_{J(max)} - T_{J(min)})$ where $T_{J(max)}$ is +125°C and $T_{J(min)}$ is –40°C.

Note 6. $V_{DO} = V_{IN} - V_{OUT}$ when V_{OUT} decreases to 98% of its nominal output voltage with $V_{IN} = V_{OUT}$ + 1V. For voltages below 2.25V, Dropout voltage is the input-to-output voltage differential with the minimum input voltage being 2.25V. Minimum input operating voltage is 2.25V.

Note 7. I_{GND} is the quiescent current. $I_{IN} = I_{GND} + I_{OUT}$.

Note 8. V_{EN} ≤ 0.8V, V_{IN} ≤ 8V, and V_{OUT} = 0V

Note 9. For a 2.5V device, V_{IN} = 2.250V (device is in dropout).

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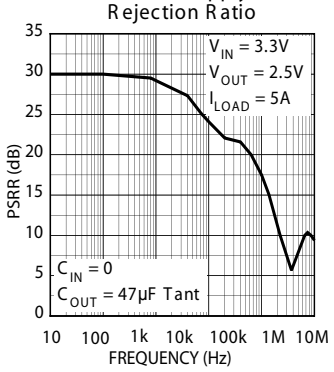
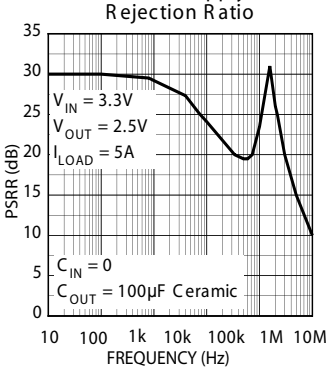
Typical Characteristics

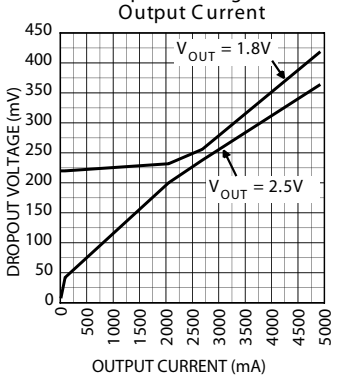
Power Supply Rejection Ratio



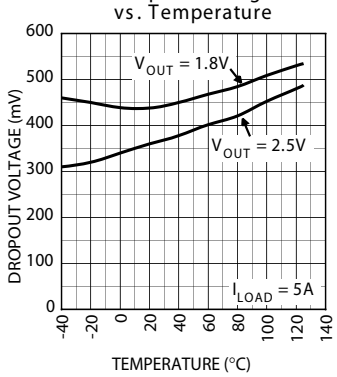
Power Supply Rejection Ratio



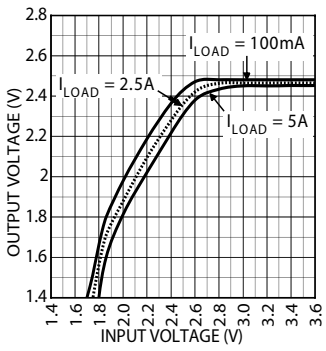
Dropout Voltage vs. Output Current



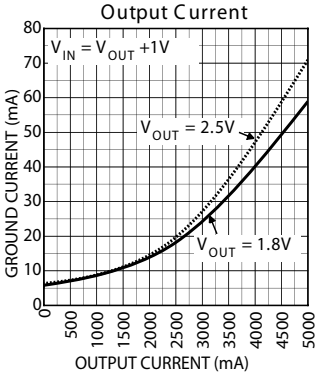
Dropout Voltage vs. Temperature



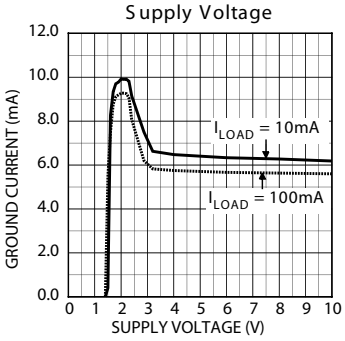
Dropout Characteristics



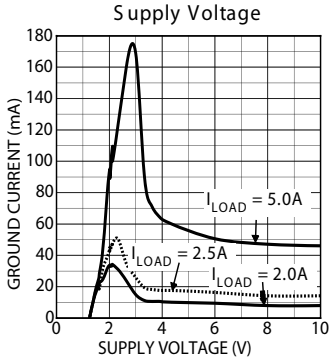
Ground Current vs. Output Current



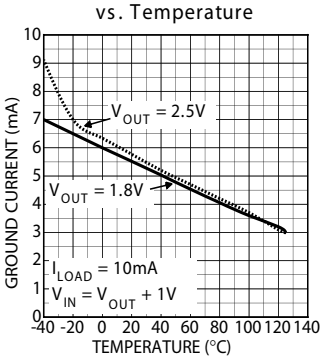
Ground Current vs. Supply Voltage



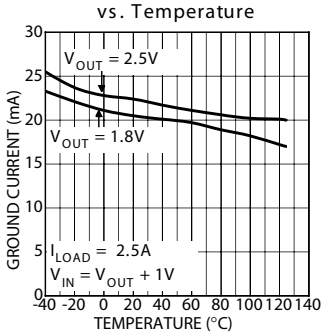
Ground Current vs. Supply Voltage



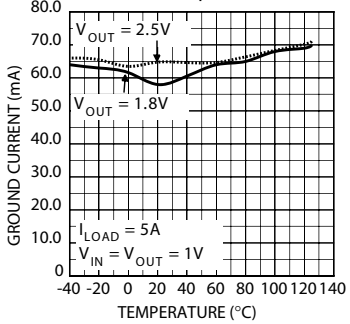
Ground Current vs. Temperature



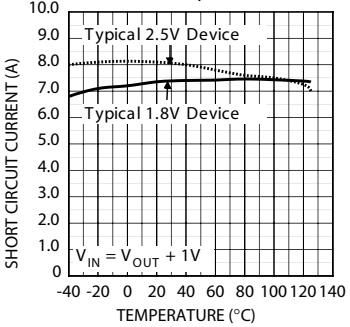
Ground Current vs. Temperature



Ground Current vs. Temperature



Short Circuit Current vs. Temperature



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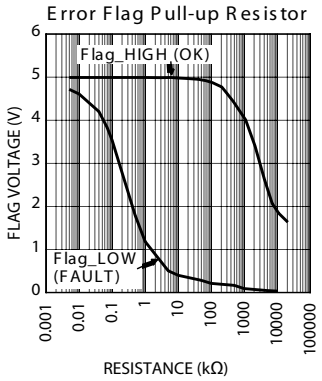

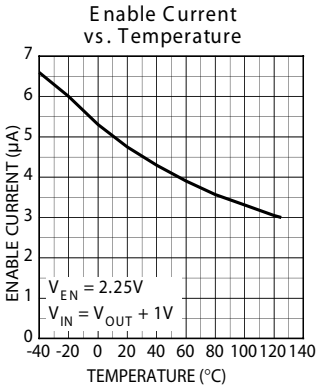

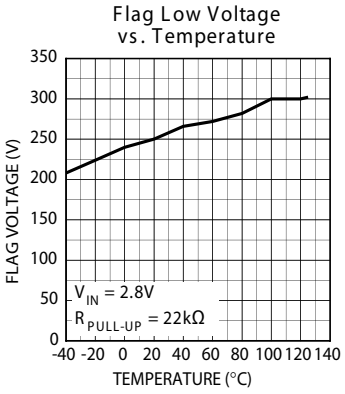

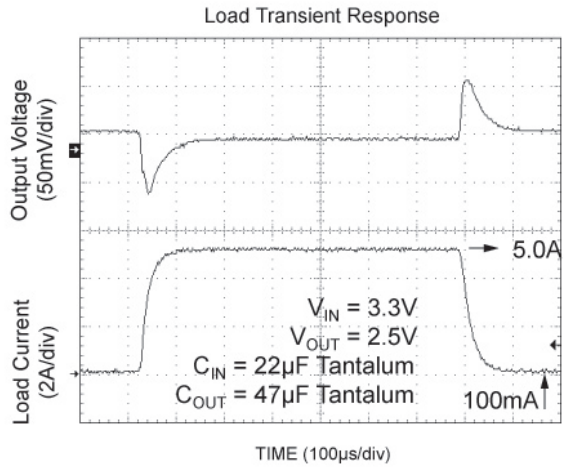

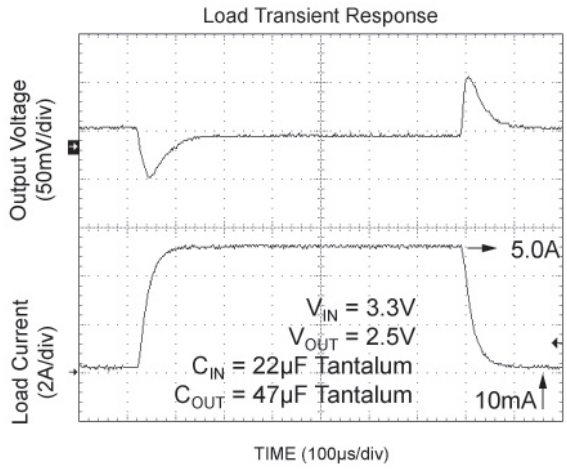

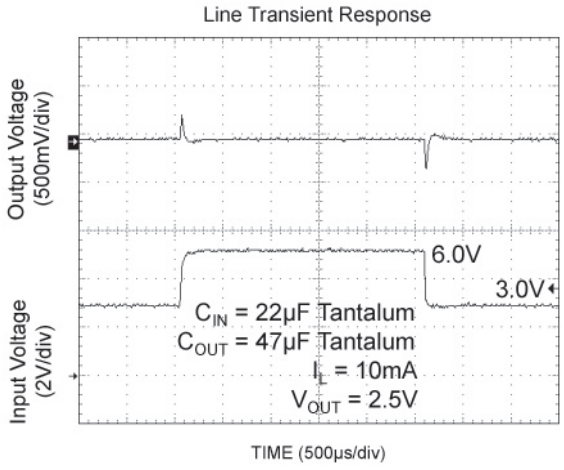

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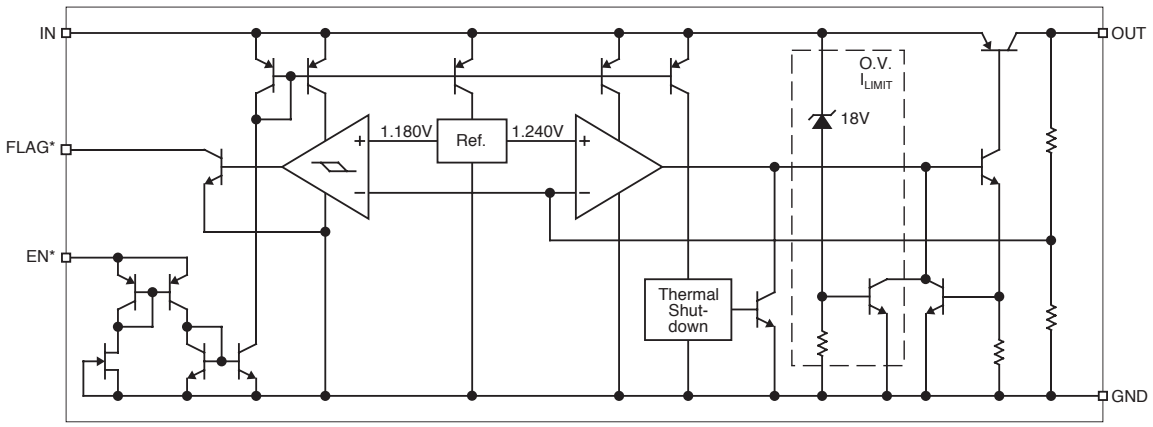
Functional Diagram



* MIC39501 only

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Applications Information

The MIC39500/1 is a high-performance low-dropout voltage regulator suitable for moderate to high-current voltage regulator applications. Its 400mV dropout voltage at full load makes it especially valuable in battery-powered systems and as a high-efficiency noise filter in post-regulator applications. Unlike older NPN-pass transistor designs, where the minimum dropout voltage is limited by the base-to-emitter voltage drop and collector-to-emitter saturation voltage, dropout performance of the PNP output of these devices is limited only by the low V_{CE} saturation voltage.

A trade-off for the low dropout voltage is a varying base drive requirement. Micrel's Super βeta PNP™ process reduces this drive requirement to only 2% to 5% of the load current.

The MIC39500/1 regulator is fully protected from damage due to fault conditions. Current limiting is provided. This limiting is linear; output current during overload conditions is constant. Thermal shutdown disables the device when the die temperature exceeds the maximum safe operating temperature. Transient protection allows device (and load) survival even when the input voltage spikes above and below nominal. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.

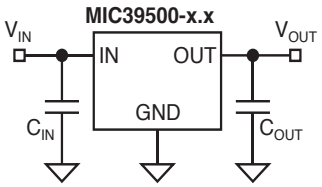

Figure 1. Capacitor Requirements

Thermal Design

Linear regulators are simple to use. The most complicated design parameters to consider are thermal characteristics. Thermal design requires four application-specific parameters:

- Maximum ambient temperature (T_A)
- Output Current (I_{OUT})
- Output Voltage (V_{OUT})
- Input Voltage (V_{IN})
- Ground Current (I_{GND})

Calculate the power dissipation of the regulator from these numbers and the device parameters from this datasheet, where the ground current is taken from data sheet.

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_{GND}$$

The heat sink thermal resistance is determined by:

$$\theta_{SA} = \frac{T_{J(max)} - T_A}{P_D} - (\theta_{JC} - \theta_{CS})$$

where:

$T_{J\,(max)} \leq 125°C$ and θ_{CS} is between 0° and 2°C/W.

The heat sink may be significantly reduced in applications where the minimum input voltage is known and is large compared with the dropout voltage. Use a series input resistor to drop excessive voltage and distribute the heat between this resistor and the regulator. The low-dropout properties of Micrel Super βeta PNP regulators allow significant reductions in regulator power dissipation and the associated heat sink without compromising performance. When this technique is employed, a capacitor of at least 1µF is needed directly between the input and regulator ground.

Refer to *Application Note 9* for further details and examples on thermal design and heat sink specification.

Output capacitor

The MIC39500/1 requires an output capacitor to maintain stability and improve transient response. Proper capacitor selection is important to ensure proper operation. The MIC39500/1 output capacitor selection is dependent upon the ESR (equivalent series resistance) of the output capacitor to maintain stability. When the output capacitor is 47µF or greater, the output capacitor should have less than 1Ω of ESR. This will improve transient response as well as promote stability. Ultra-low-ESR capacitors, such as ceramic chip capacitors may promote instability. These very low ESR levels may cause an oscillation and/or underdamped transient response. When larger capacitors are used, the ESR requirement approaches zero. A 100µF ceramic capacitor can be used on the output while maintaining stability. A low-ESR 47µF solid tantalum capacitor works extremely well and provides good transient response and stability over temperature. Aluminum electrolytics can also be used, as long as the ESR of the capacitor is $\leq 1\Omega$.

The value of the output capacitor can be increased without limit. Higher capacitance values help to improve transient response and ripple rejection and reduce output noise.

Input capacitor

An input capacitor of 1µF or greater is recommended when the device is more than 4 inches away from the bulk ac supply capacitance, or when the supply is a battery. Small surface-mount ceramic chip capacitors can be used for bypassing. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage.

Transient Response and 3.3V to 2.5V or 2.5V to 1.8V Conversion

The MIC39500/1 has excellent transient response to variations in input voltage and load current. The device has been designed to respond quickly to load current variations and input voltage variations. Large output capacitors are not required to obtain this performance. A standard 47µF output capacitor, preferably tantalum, is all that is required. Larger values improve performance even further.

By virtue of its low-dropout voltage, this device does not saturate into dropout as readily as similar NPN-based designs. When converting from 3.3V to 2.5V, or 2.5V to 1.8V, the NPN-based regulators are already operating in dropout, with typical dropout requirements of 1.2V or greater. To convert down to 2.5V without operating in dropout, NPN-based regulators require an input voltage of 3.7V at the very least. The MIC39500/1 regulator provides excellent performance

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with an input as low as 3.0V or 2.5V respectively. This gives PNP-based regulators a distinct advantage over older, NPN-based linear regulators.

A typical NPN regulator does not have the headroom to do this conversion.

Minimum Load Current

The MIC39500/1 regulator is specified between finite loads. If the output current is too small, leakage currents dominate and the output voltage rises. A 10mA minimum load current is necessary for proper regulation.

Error Flag

The MIC39501 version features an error flag circuit which monitors the output voltage and signals an error condition when the voltage 5% below the nominal output voltage. The error flag is an open-collector output that can sink 10mA during a fault condition.

Low output voltage can be caused by a number of problems, including an overcurrent fault (device in current limit) or low input voltage. The flag is inoperative during overtemperature shutdown.

When the error flag is not used, it is best to leave it open. The flag pin can be tied directly to pin 4, the output pin.

Enable Input

The MIC39501 version features an enable input for on/off control of the device. Its shutdown state draws “zero” current (only microamperes of leakage). The enable input is TTL/CMOS compatible for simple logic interface, but can be connected to up to 20V.

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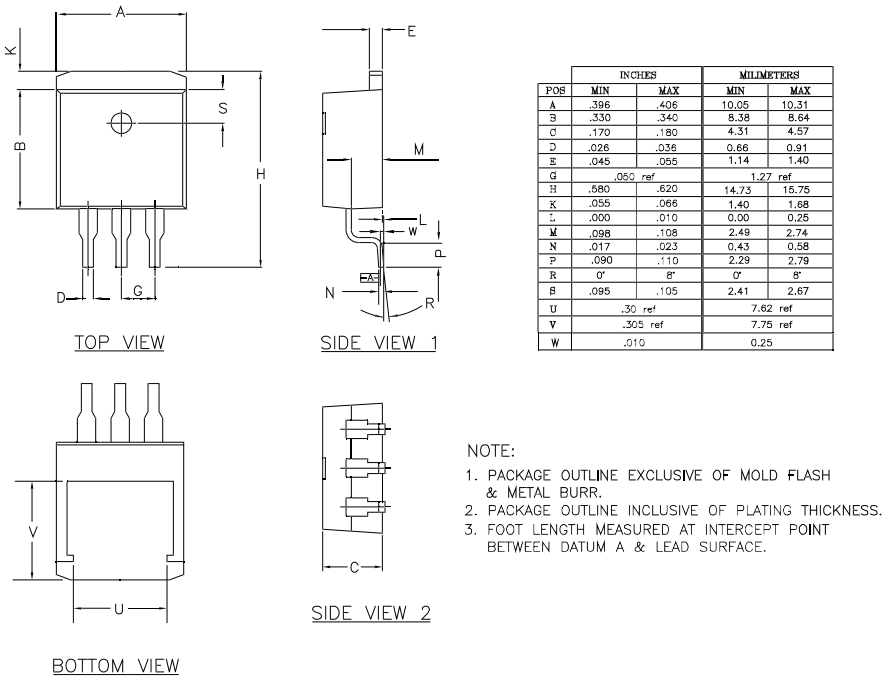
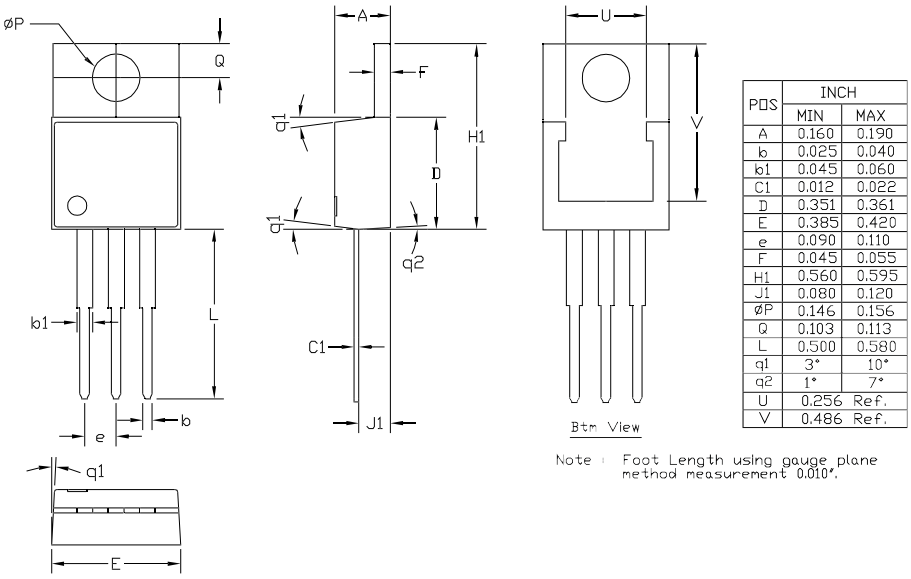
Package Information



POS	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.396	.406	10.05	10.31
B	.330	.340	8.38	8.64
C	.170	.180	4.31	4.57
D	.026	.036	0.66	0.91
E	.045	.055	1.14	1.40
G	.050 ref		1.27 ref	
H	.580	.620	14.73	15.75
K	.055	.066	1.40	1.68
L	.000	.010	0.00	0.25
M	.098	.108	2.49	2.74
N	.017	.023	0.43	0.58
P	.090	.110	2.29	2.79
R	0°	8°	0°	8°
S	.095	.105	2.41	2.67
U	.30 ref		7.62 ref	
V	.305 ref		7.75 ref	
W	.010		0.25	

NOTE:
1. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & METAL BURR.
2. PACKAGE OUTLINE INCLUSIVE OF PLATING THICKNESS.
3. FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE.

3-Lead TO-263 (U)



POS	INCH MIN	INCH MAX
A	0.160	0.190
b	0.025	0.040
b1	0.045	0.060
C1	0.012	0.022
D	0.351	0.361
E	0.385	0.420
e	0.090	0.110
F	0.045	0.055
H1	0.560	0.595
J1	0.080	0.120
øP	0.146	0.156
Q	0.103	0.113
L	0.500	0.580
q1	3°	10°
q2	1°	7°
U	0.256 Ref.	
V	0.486 Ref.	

3-Lead TO-220 (T)

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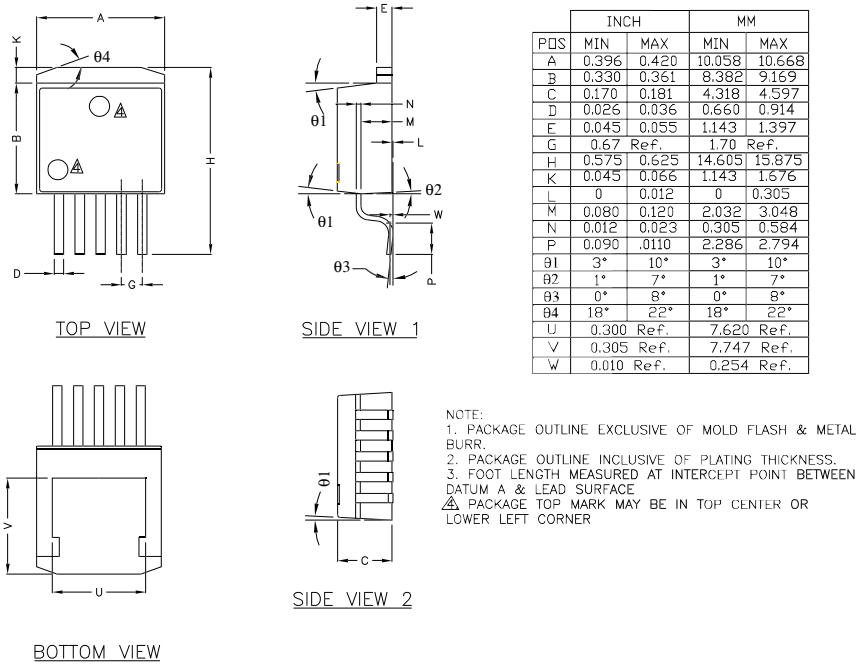
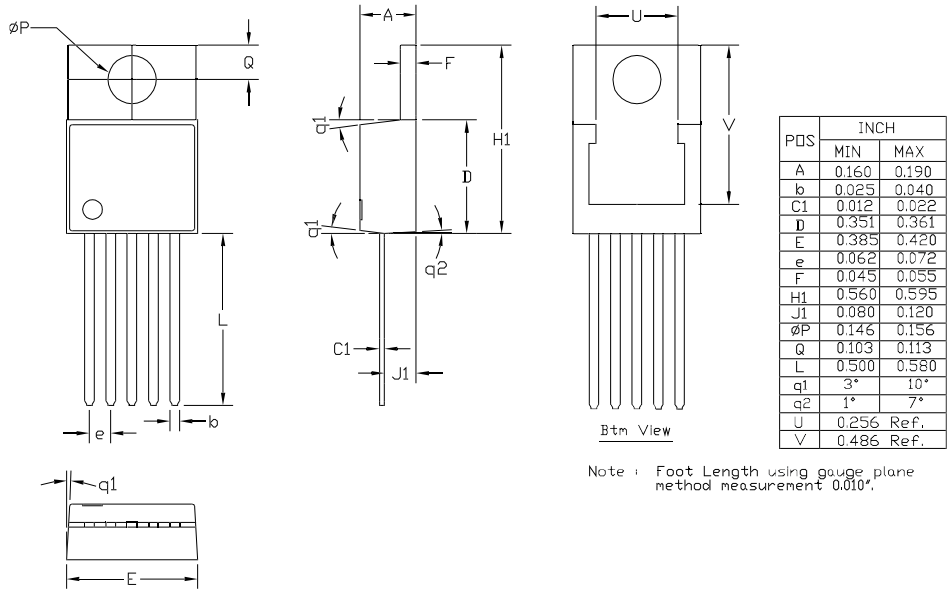


POS	INCH		MM	
	MIN	MAX	MIN	MAX
A	0.396	0.420	10.058	10.668
B	0.330	0.361	8.382	9.169
C	0.170	0.181	4.318	4.597
D	0.026	0.036	0.660	0.914
E	0.045	0.055	1.143	1.397
G	0.67 Ref.		1.70 Ref.	
H	0.575	0.625	14.605	15.875
K	0.045	0.066	1.143	1.676
L	0	0.012	0	0.305
M	0.080	0.120	2.032	3.048
N	0.012	0.023	0.305	0.584
P	0.090	.0110	2.286	2.794
θ1	3°	10°	3°	10°
θ2	1°	7°	1°	7°
θ3	0°	8°	0°	8°
θ4	18°	22°	18°	22°
U	0.300 Ref.		7.620 Ref.	
V	0.305 Ref.		7.747 Ref.	
W	0.010 Ref.		0.254 Ref.	

NOTE:
1. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & METAL BURR.
2. PACKAGE OUTLINE INCLUSIVE OF PLATING THICKNESS.
3. FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE.
4. PACKAGE TOP MARK MAY BE IN TOP CENTER OR LOWER LEFT CORNER

5-Lead TO-263-5 (U)



POS	INCH	
	MIN	MAX
A	0.160	0.190
b	0.025	0.040
C1	0.012	0.022
D	0.351	0.361
E	0.385	0.420
e	0.062	0.072
F	0.045	0.055
H1	0.560	0.595
J1	0.080	0.120
ØP	0.146	0.156
Q	0.103	0.113
L	0.500	0.580
q1	3°	10°
q2	1°	7°
U	0.256 Ref.	
V	0.486 Ref.	

Note : Foot Length using gauge plane method measurement 0.010".

5-Lead TO-220 (T)

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